Tyrone Camarero Specifications

Tyrone

Camerero: ADI100A2N-110

Key Feature

- 3rd Gen Intel® Xeon® Scalable Processors
- Supports 16 DDR4 DIMM slots ,DDR4 3200/2933MHz RDIMM/LRDIMM
- Onboard Baseboard Management Controller for system

 Management and

 IPML control
- 10 x 2.5": 2 x (SATA or PCle Gen4 NVMe) + 8 x (SAS*/SATA/PCle Gen4 NVMe or SAS/SATA), 2 x M.2
- 2 x PCle Gen4 x16 slots (HHHL; one with FH I/O bracket) + 1 x OCP V3.0
- 10 x SATA 6.0 Gb/s
- 6 x 40x56mm easy swap fans, 1 x 40x28mm fan
- 750W/1100W 1+1 redundant power supply 80+ Platinum





Processor/C	ac	he
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Processor 3rd Gen Intel® Xeon® Scalable Processors (Ice

Lake)

Chipset

Chipset Intel C621A chipset

System Memory

Memory Suppor Capacity 3200/2

Supports 16 DDR4 DIMM slots ,DDR4 3200/2933MHz RDIMM/LRDIMM

Expansion Slot

PCI-Express 2 x PCIe Gen4 x16 slots (HHHL; one with

FH I/O bracket) + 1 x OCP V3.0

Integrated Onboard:

SATA 10 x SATA 6.0 Gb/s

LAN 1 x GbE RJ45

Add-on Options

Raid Card Optional

Optical N

Drive

None

Front Panel

Front Panel System power on/off, System reset, 2 x

USB 3.0 Type A

Ports 1xGbE RJ45, 2 x USB 3.0 , 1 x VGA , 1x

Serial ports

LEDs Power statusm,HDD activity, LAN

activity, Warning

Drive bays

HDD Bays 10 x 2.5" : 2 x (SATA or PCle Gen4

NVMe) + 8 x (SAS*/SATA/PCle Gen4

NVMe or SAS/SATA)

Power Supply

Power Supply 750W/1100W 1+1 redundant power

supply 80+ Platinum

Cooling System

6 x 40x56mm easy swap fans, 1 x 40x28mm fan

Form Factor

Form Factor 1U Rackmount

Dimensions

Dimensions (W x D x H) : 615 x 1025 x 274

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www.tyronesystems.com

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